

# STARPOWER

SEMICONDUCTOR

**IGBT**

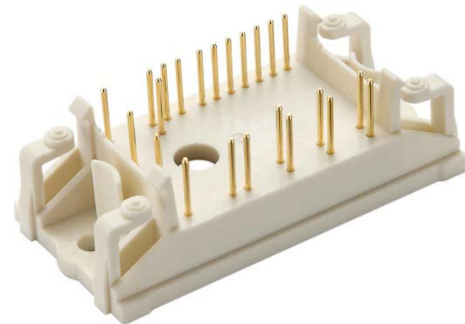
## GD15PJT120F3S\_T4

Molding Type Module

**1200V/15A PIM in one-package**

### General Description

STARPOWER IGBT Power Module provides ultra low conduction loss as well as short circuit ruggedness. They are designed for the applications such as general inverters and UPS.



### Features

- Low  $V_{CE(sat)}$  Trench IGBT technology
- 10 $\mu$ s short circuit capability
- $V_{CE(sat)}$  with positive temperature coefficient
- Maximum junction temperature 175 °C
- Fast & soft reverse recovery anti-parallel FWD

### Typical Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

**IGBT-inverter**  $T_C=25^\circ\text{C}$  unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD15PJT120F3S_T4	Units
$V_{CES}$	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
$V_{GES}$	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^\circ\text{C}$ @ $T_C=100^\circ\text{C}$	28 15	A
$I_{CM}$	Pulsed Collector Current $t_p=1\text{ms}$	30	A
$P_{tot}$	Total Power Dissipation @ $T_j=175^\circ\text{C}$	120	W

**Off Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V},$ $T_j=25^\circ\text{C}$			1.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V},$ $T_j=25^\circ\text{C}$			400	nA

**On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=0.48\text{mA}, V_{CE}=V_{GE},$ $T_j=25^\circ\text{C}$	5.2	5.8	6.4	V
$V_{CE(sat)}$ (chip)	Collector to Emitter Saturation Voltage	$I_C=15\text{A}, V_{GE}=15\text{V},$ $T_j=25^\circ\text{C}$		1.85	2.30	V
		$I_C=15\text{A}, V_{GE}=15\text{V},$ $T_j=125^\circ\text{C}$		2.15		
		$I_C=15\text{A}, V_{GE}=15\text{V},$ $T_j=150^\circ\text{C}$		2.25		

## Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=15A,$ $R_G=39\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		55		ns
$t_r$	Rise Time			59		ns
$t_{d(off)}$	Turn-Off Delay Time			195		ns
$t_f$	Fall Time			145		ns
$E_{on}$	Turn-On Switching Loss			1.29		mJ
$E_{off}$	Turn-Off Switching Loss			0.84		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=15A,$ $R_G=39\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		55		ns
$t_r$	Rise Time			65		ns
$t_{d(off)}$	Turn-Off Delay Time			275		ns
$t_f$	Fall Time			190		ns
$E_{on}$	Turn-On Switching Loss			1.76		mJ
$E_{off}$	Turn-Off Switching Loss			1.19		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=15A,$ $R_G=39\Omega, V_{GE}=\pm 15V,$ $T_j=150^\circ C$		55		ns
$t_r$	Rise Time			65		ns
$t_{d(off)}$	Turn-Off Delay Time			280		ns
$t_f$	Fall Time			215		ns
$E_{on}$	Turn-On Switching Loss			1.96		mJ
$E_{off}$	Turn-Off Switching Loss			1.34		mJ
$C_{ies}$	Input Capacitance	$V_{CE}=25V, f=1Mhz,$ $V_{GE}=0V$		0.89		nF
$C_{oes}$	Output Capacitance			0.08		nF
$C_{res}$	Reverse Transfer Capacitance			0.03		nF
$Q_G$	Gate Charge	$V_{CC}=600V, I_C=15A,$ $V_{GE}=-15 \dots +15V$		120		nC
$R_{Gint}$	Internal Gate Resister			/		$\Omega$
$I_{SC}$	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=150^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		55		A

**Diode-inverter**  $T_C=25^\circ\text{C}$  unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD15PJT120F3S_T4	Units
$V_{RRM}$	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1200	V
$I_F$	DC Forward Current	15	A
$I_{FRM}$	Repetitive Peak Forward Current $t_p=1\text{ms}$	30	A

**Characteristics Values**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$ (chip)	Diode Forward Voltage	$I_F=15\text{A}$ , $V_{GE}=0\text{V}$	$T_j=25^\circ\text{C}$	2.05	2.50	V
			$T_j=125^\circ\text{C}$	2.00		
			$T_j=150^\circ\text{C}$	2.00		
$Q_r$	Recovered Charge	$I_F=15\text{A}$ , $V_R=600\text{V}$ , $R_G=39\Omega$ , $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	1.3		$\mu\text{C}$
			$T_j=125^\circ\text{C}$	2.2		
			$T_j=150^\circ\text{C}$	2.4		
$I_{RM}$	Peak Reverse Recovery Current	$I_F=15\text{A}$ , $V_R=600\text{V}$ , $R_G=39\Omega$ , $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	13		A
			$T_j=125^\circ\text{C}$	15		
			$T_j=150^\circ\text{C}$	15		
$E_{rec}$	Reverse Recovery Energy	$I_F=15\text{A}$ , $V_R=600\text{V}$ , $R_G=39\Omega$ , $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	0.60		mJ
			$T_j=125^\circ\text{C}$	1.10		
			$T_j=150^\circ\text{C}$	1.22		

**Diode-rectifier**  $T_C=25^\circ\text{C}$  unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD15PJT120F3S_T4	Units
$V_{RRM}$	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1600	V
$I_{F(AV)}$	Average On-state Current @ $T_C=100^\circ\text{C}$	20	A
$I_{RMSM}$	Maximum RMS Current At Rectifier Output @ $T_C=80^\circ\text{C}$	40	A
$I_{FSM}$	Surge Forward Current $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	270	A
$I^2t$	$I^2t$ -value, $V_R=0\text{V}, t_p=10\text{ms}, T_j=45^\circ\text{C}$	360	$\text{A}^2\text{s}$

**Characteristics Values**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$ (chip)	Diode Forward Voltage	$I_F=20\text{A}$		1.05		V
$I_R$	Reverse Current	$T_j=150^\circ\text{C}, V_R=1600\text{V}$			1.0	mA

**IGBT-brake-chopper**  $T_C=25^\circ\text{C}$  unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD15PJT120F3S_T4	Units
$V_{CES}$	Collector-Emitter Voltage @ $T_j=25^\circ\text{C}$	1200	V
$V_{GES}$	Gate-Emitter Voltage @ $T_j=25^\circ\text{C}$	$\pm 20$	V
$I_C$	Collector Current @ $T_C=25^\circ\text{C}$	20	A
	@ $T_C=100^\circ\text{C}$	10	
$I_{CM}$	Pulsed Collector Current $t_p=1\text{ms}$	20	A
$P_{tot}$	Total Power Dissipation @ $T_j=175^\circ\text{C}$	94	W

**Off Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{(BR)CES}$	Collector-Emitter Breakdown Voltage	$T_j=25^\circ\text{C}$	1200			V
$I_{CES}$	Collector Cut-Off Current	$V_{CE}=V_{CES}, V_{GE}=0\text{V}, T_j=25^\circ\text{C}$			1.0	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=V_{GES}, V_{CE}=0\text{V}, T_j=25^\circ\text{C}$			400	nA

**On Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=125\mu\text{A}, V_{CE}=V_{GE}, T_j=25^\circ\text{C}$	5.0	5.9	7.5	V
$V_{CE(sat)}$ (chip)	Collector to Emitter Saturation Voltage	$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=25^\circ\text{C}$		2.10	2.55	V
		$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=125^\circ\text{C}$		2.50		
		$I_C=10\text{A}, V_{GE}=15\text{V}, T_j=150^\circ\text{C}$		2.60		

## Switching Characteristics

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=10A,$ $R_G=22\Omega, V_{GE}=\pm 15V,$ $T_j=25^\circ C$		14		ns
$t_r$	Rise Time			24		ns
$t_{d(off)}$	Turn-Off Delay Time			110		ns
$t_f$	Fall Time			38		ns
$E_{on}$	Turn-On Switching Loss			0.53		mJ
$E_{off}$	Turn-Off Switching Loss			0.38		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=10A,$ $R_G=22\Omega, V_{GE}=\pm 15V,$ $T_j=125^\circ C$		15		ns
$t_r$	Rise Time			25		ns
$t_{d(off)}$	Turn-Off Delay Time			125		ns
$t_f$	Fall Time			220		ns
$E_{on}$	Turn-On Switching Loss			0.69		mJ
$E_{off}$	Turn-Off Switching Loss			0.58		mJ
$t_{d(on)}$	Turn-On Delay Time	$V_{CC}=600V, I_C=10A,$ $R_G=22\Omega, V_{GE}=\pm 15V,$ $T_j=150^\circ C$		15		ns
$t_r$	Rise Time			25		ns
$t_{d(off)}$	Turn-Off Delay Time			128		ns
$t_f$	Fall Time			250		ns
$E_{on}$	Turn-On Switching Loss			0.76		mJ
$E_{off}$	Turn-Off Switching Loss			0.66		mJ
$C_{ies}$	Input Capacitance	$V_{CE}=30V, f=1Mhz,$ $V_{GE}=0V$		1.07		nF
$C_{oes}$	Output Capacitance			0.06		nF
$C_{res}$	Reverse Transfer Capacitance			0.03		nF
$Q_G$	Gate Charge	$V_{CC}=600V, I_C=10A,$ $V_{GE}=15V$		50		nC
$R_{Gint}$	Internal Gate Resister			/		$\Omega$
$I_{SC}$	SC Data	$t_p \leq 10\mu s, V_{GE}=15V,$ $T_j=150^\circ C, V_{CC}=900V,$ $V_{CEM} \leq 1200V$		90		A

**Diode-brake-chopper**  $T_C=25^\circ\text{C}$  unless otherwise noted**Maximum Rated Values**

Symbol	Description	GD15PJT120F3S_T4	Units
$V_{RRM}$	Repetitive Peak Reverse Voltage @ $T_j=25^\circ\text{C}$	1200	V
$I_F$	DC Forward Current	10	A
$I_{FRM}$	Repetitive Peak Forward Current $t_p=1\text{ms}$	20	A

**Characteristics Values**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$V_F$ (chip)	Diode Forward Voltage	$I_F=10\text{A}$ , $V_{GE}=0\text{V}$	$T_j=25^\circ\text{C}$	1.85	2.30	V
			$T_j=125^\circ\text{C}$	2.05		
			$T_j=150^\circ\text{C}$	2.10		
$Q_r$	Recovered Charge	$I_F=10\text{A}$ , $V_R=600\text{V}$ , $R_G=100\Omega$ , $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	0.98		$\mu\text{C}$
			$T_j=125^\circ\text{C}$	1.51		
			$T_j=150^\circ\text{C}$	1.70		
$I_{RM}$	Peak Reverse Recovery Current	$I_F=10\text{A}$ , $V_R=600\text{V}$ , $R_G=100\Omega$ , $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	6.6		A
			$T_j=125^\circ\text{C}$	8.0		
			$T_j=150^\circ\text{C}$	8.1		
$E_{rec}$	Reverse Recovery Energy	$I_F=10\text{A}$ , $V_R=600\text{V}$ , $R_G=100\Omega$ , $V_{GE}=-15\text{V}$	$T_j=25^\circ\text{C}$	0.36		mJ
			$T_j=125^\circ\text{C}$	0.53		
			$T_j=150^\circ\text{C}$	0.62		

**NTC**  $T_C=25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
$R_{25}$	Rated Resistance			22.0		$\text{k}\Omega$
$\Delta R/R$	Deviation of $R_{100}$	$T_C=100^\circ\text{C}$ , $R_{100}=1486.1\Omega$	-5		5	%
$P_{25}$	Power Dissipation				200	mW
$B_{25/50}$	B-value	$R_2=R_{25}\exp[B_{25/50}(1/T_2-1/(298.15\text{K}))]$		4000		K

**IGBT Module**

Symbol	Parameter	Min.	Typ.	Max.	Units
$V_{ISO}$	Isolation Voltage RMS, $f=50\text{Hz}$ , $t=1\text{min}$	4000			V
$R_{\theta JC}$	Junction-to-Case (per IGBT-inverter)			1.254	K/W
	Junction-to-Case (per Diode-inverter)			2.231	
	Junction-to-Case (per Diode-rectifier)			1.623	
	Junction-to-Case (per IGBT-brake-chopper)			1.588	
	Junction-to-Case (per Diode-brake-chopper)			2.434	
$R_{\theta CS}$	Case-to-Sink (per IGBT-inverter)		0.551		K/W
	Case-to-Sink (per Diode-inverter)		0.981		
	Case-to-Sink (per Diode-rectifier)		0.713		
	Case-to-Sink (per IGBT-brake-chopper)		0.698		
	Case-to-Sink (per Diode-brake-chopper)		1.070		
$R_{\theta CS}$	Case-to-Sink (Conductive grease applied)		0.036		K/W
$T_{jmax}$	Maximum Junction Temperature (inverter,brake)			175	°C
	Maximum Junction Temperature(rectifier)			150	
$T_{jop}$	Operating Junction Temperature	-40		150	°C
$T_{STG}$	Storage Temperature Range	-40		125	°C



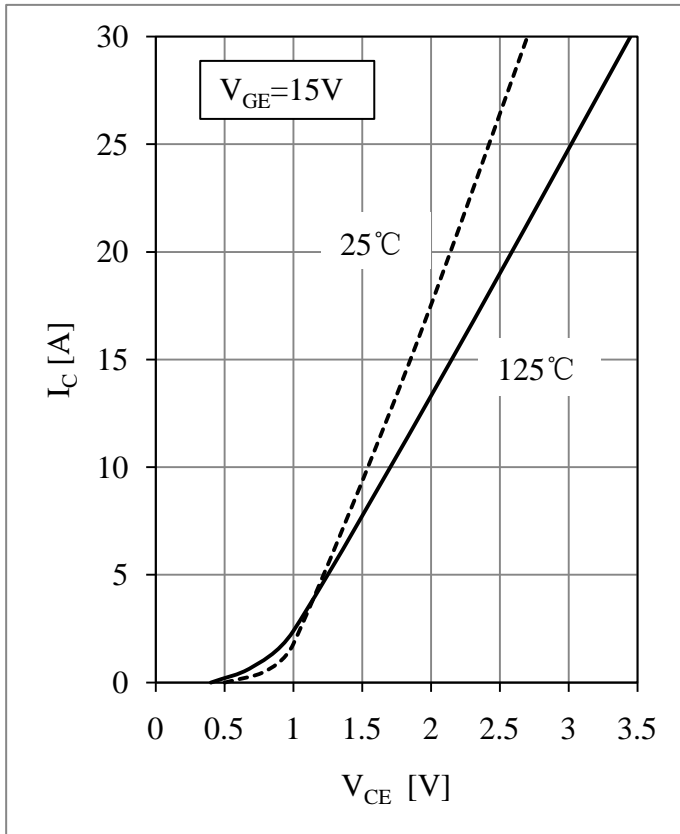


Fig 1. IGBT-inverter Output Characteristics

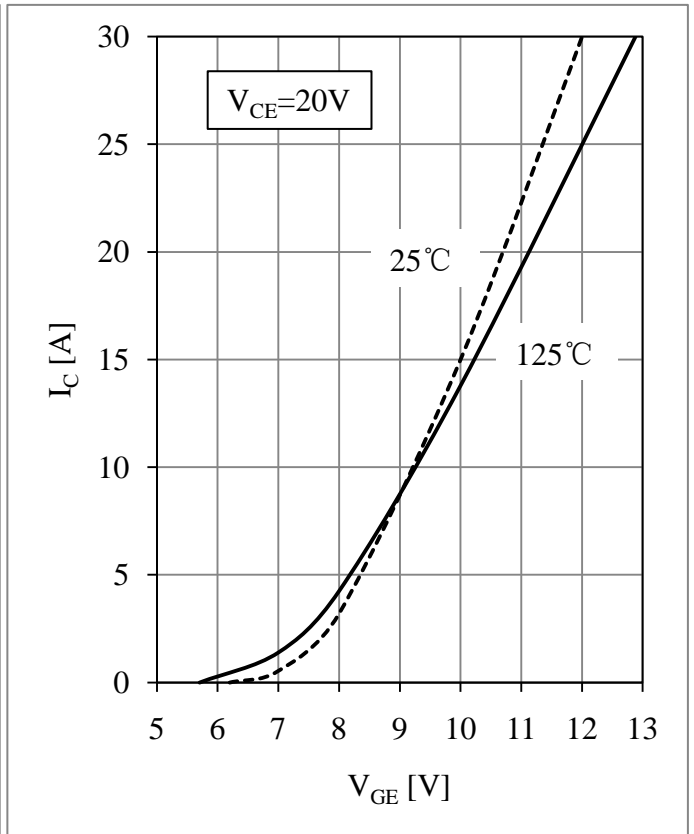


Fig 2. IGBT-inverter Transfer Characteristics

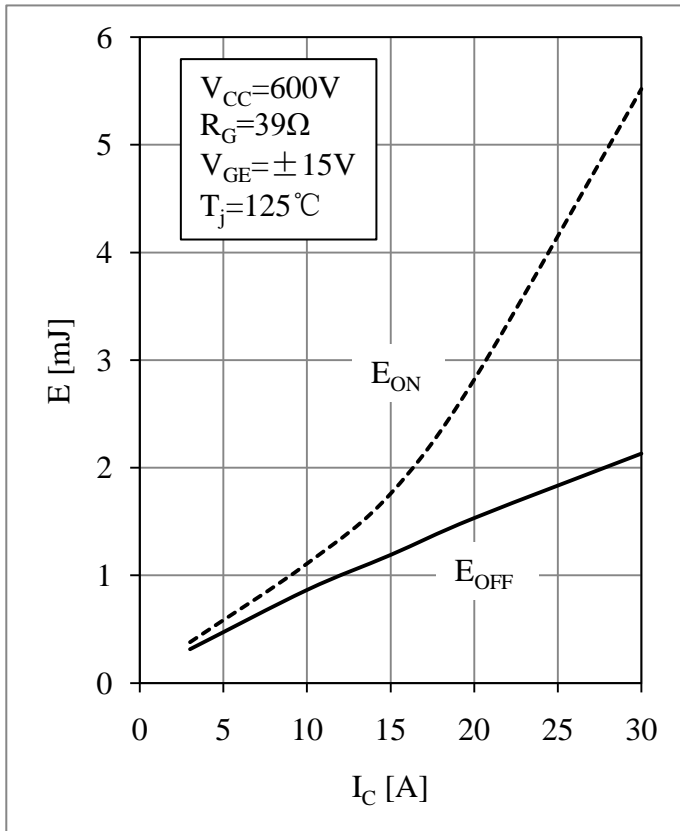


Fig 3. IGBT-inverter Switching Loss vs.  $I_C$

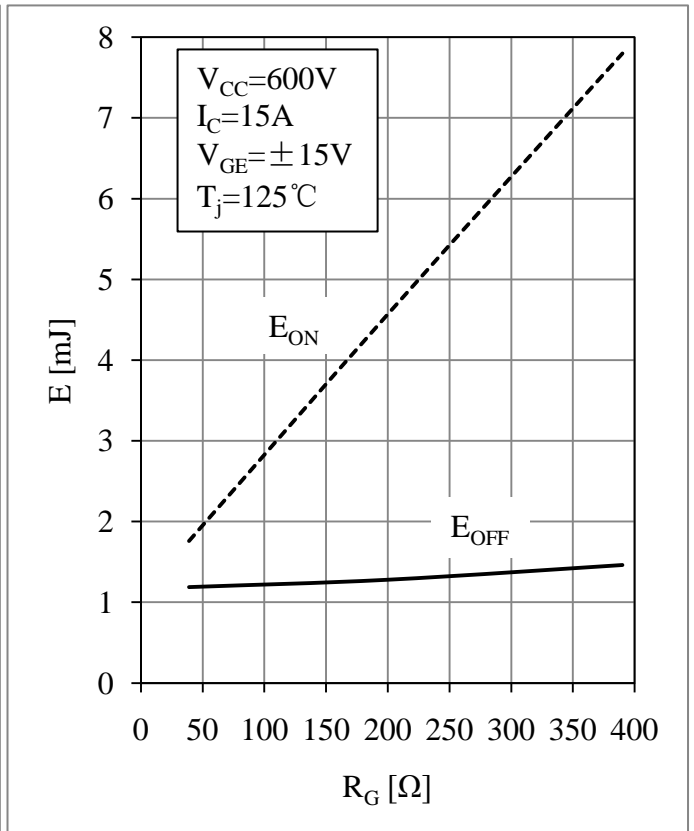


Fig 4. IGBT-inverter Switching Loss vs.  $R_G$

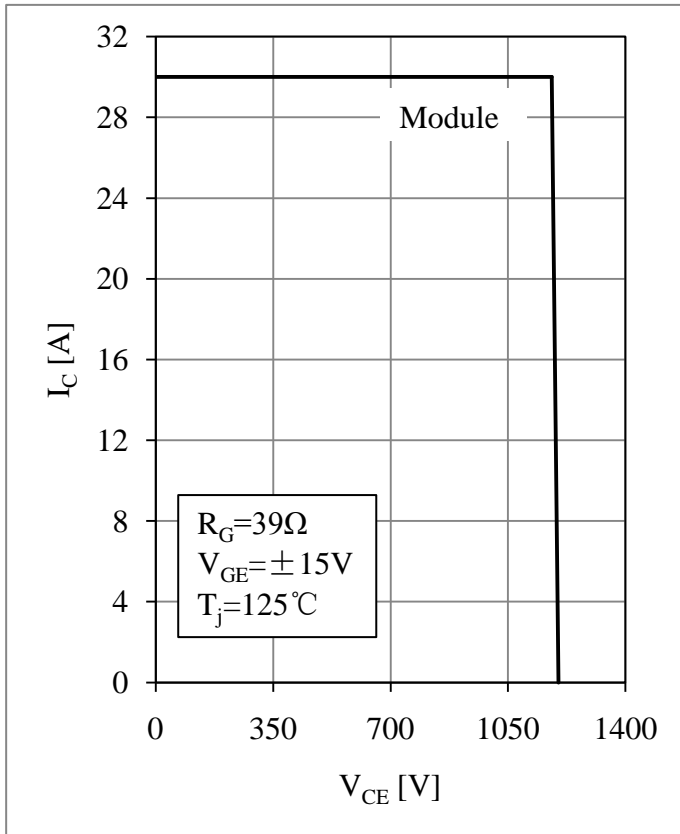


Fig 5. IGBT-inverter RBSOA

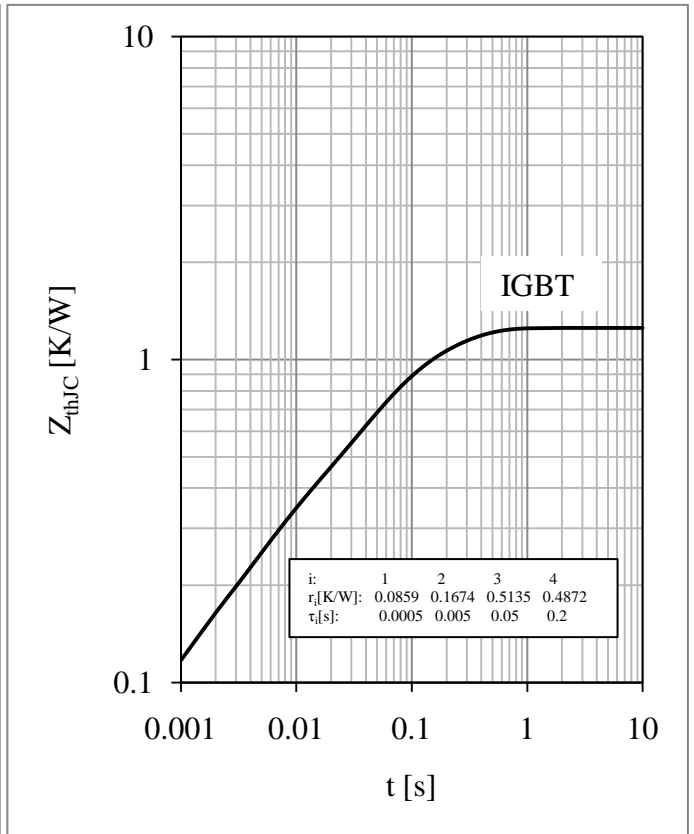


Fig 6. IGBT-inverter Transient Thermal Impedance

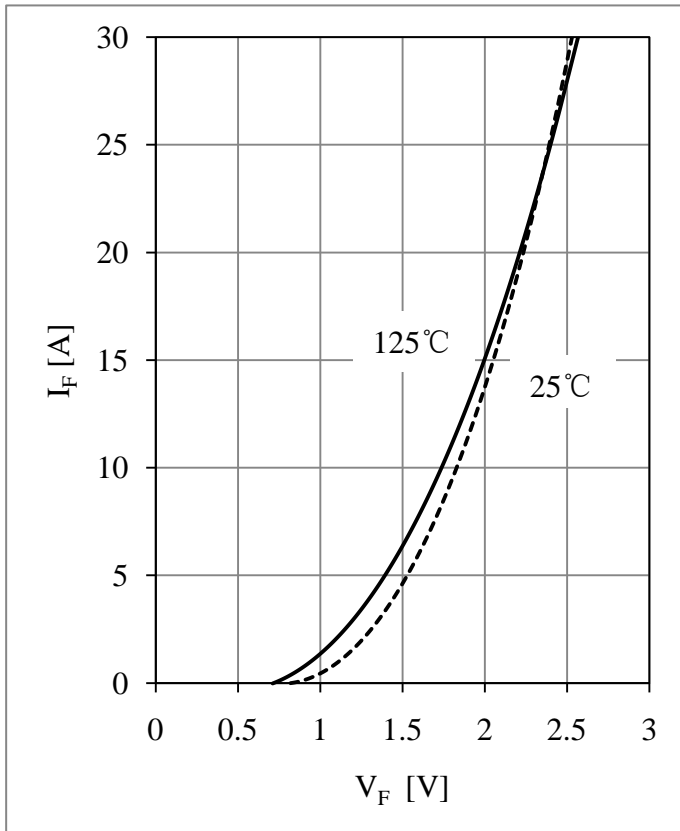


Fig 7. Diode-inverter Forward Characteristics

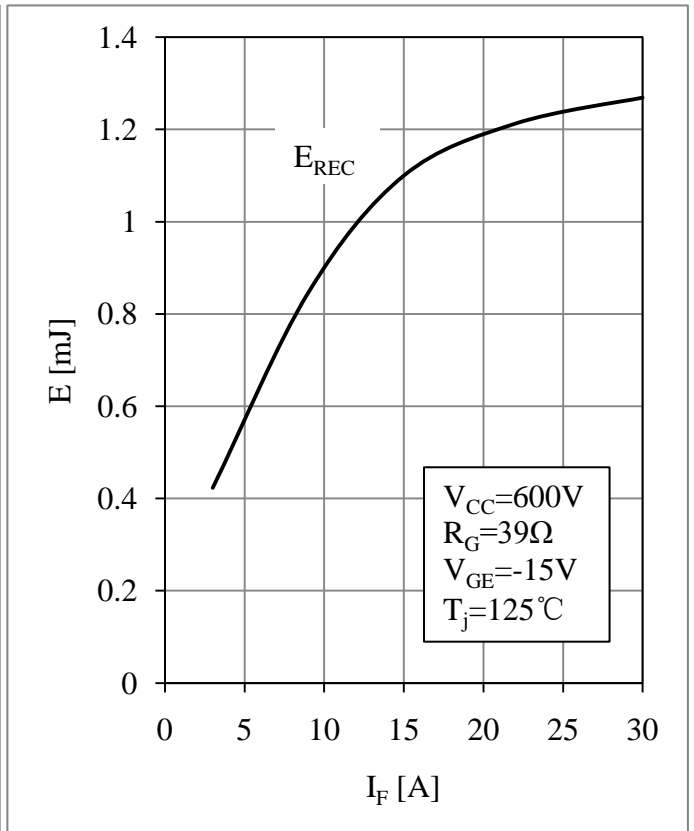


Fig 8. Diode-inverter Switching Loss vs.  $I_F$

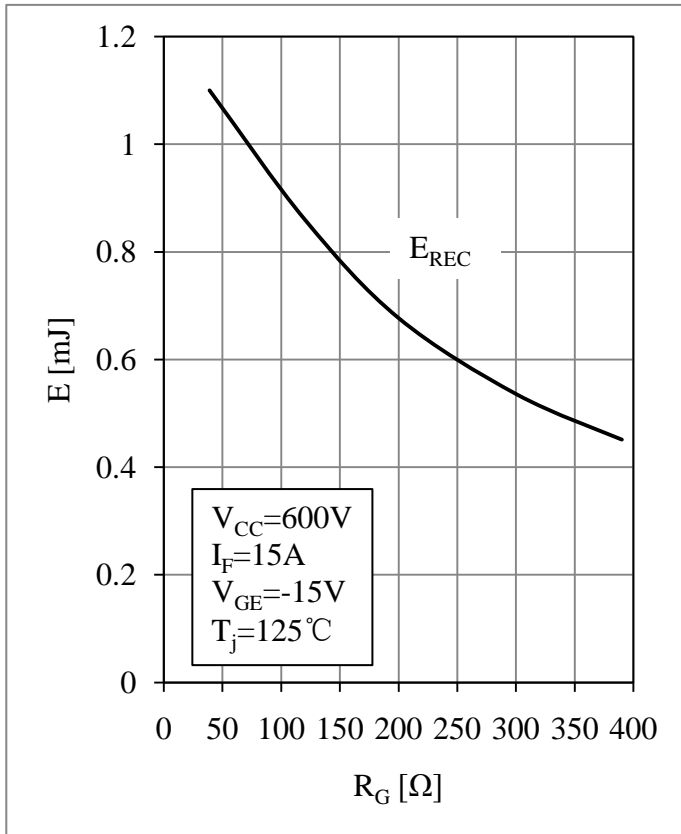


Fig 9. Diode-inverter Switching Loss vs.  $R_G$

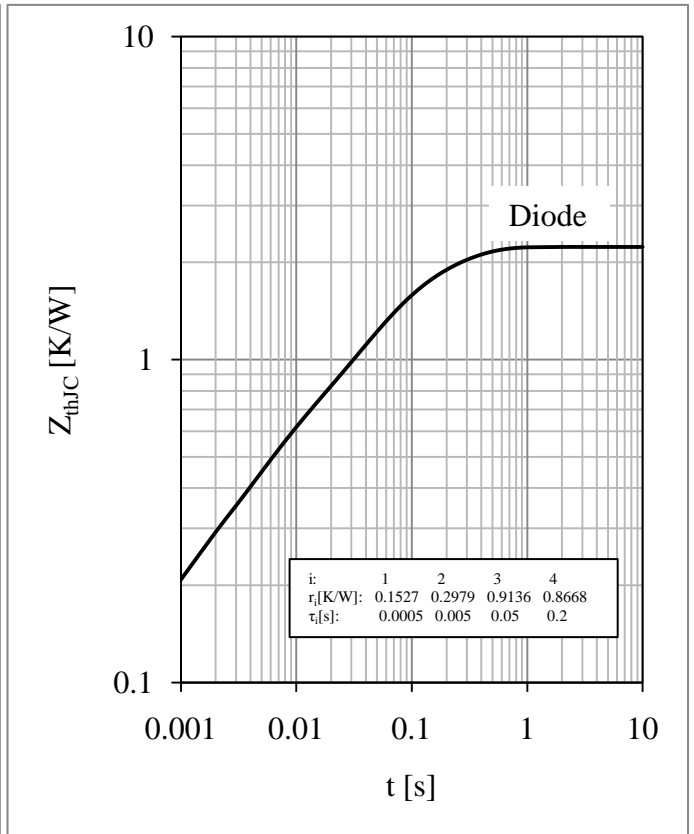


Fig 10. Diode-inverter Transient Thermal Impedance

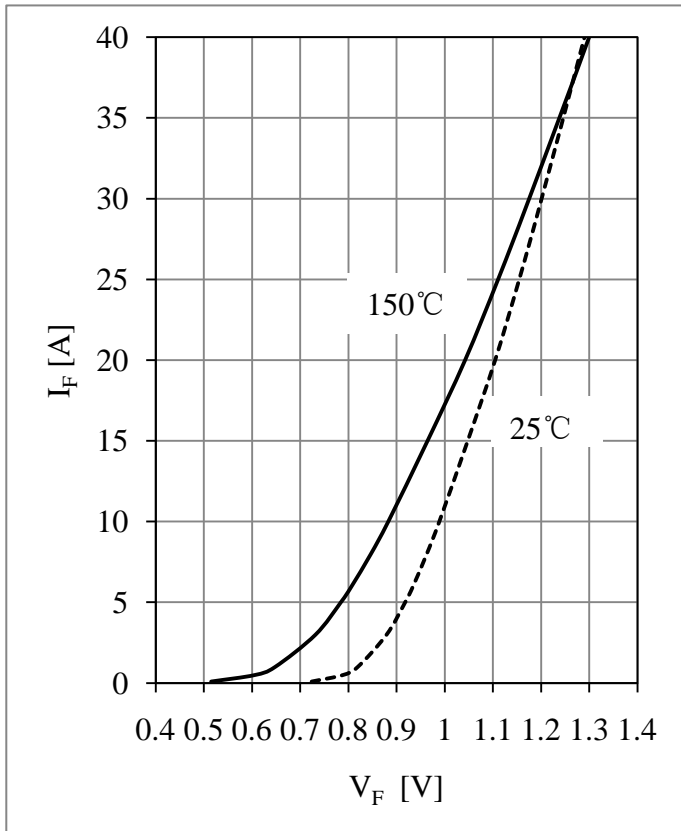


Fig 11. Diode-rectifier Forward Characteristics

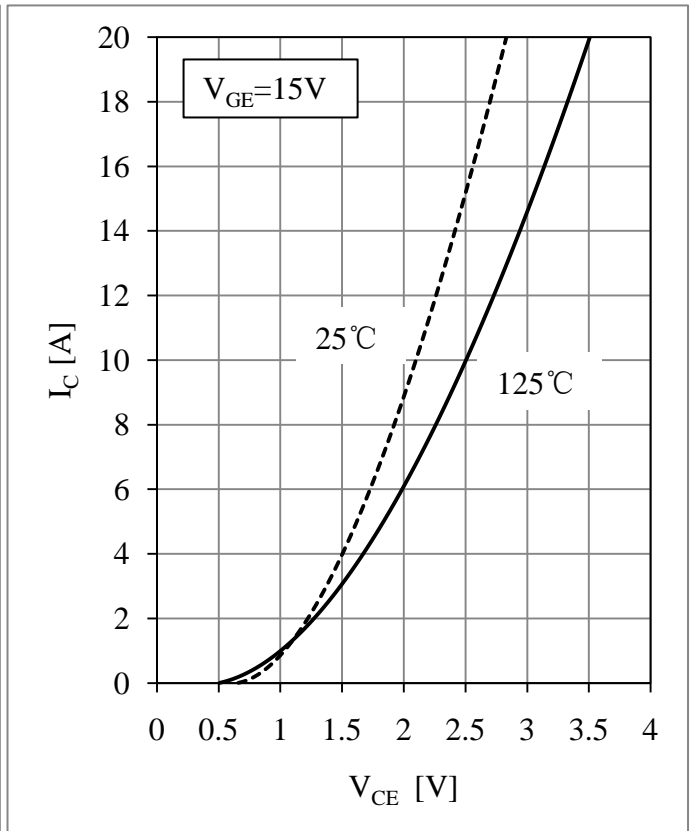


Fig 12. IGBT-brake-chopper Output Characteristics

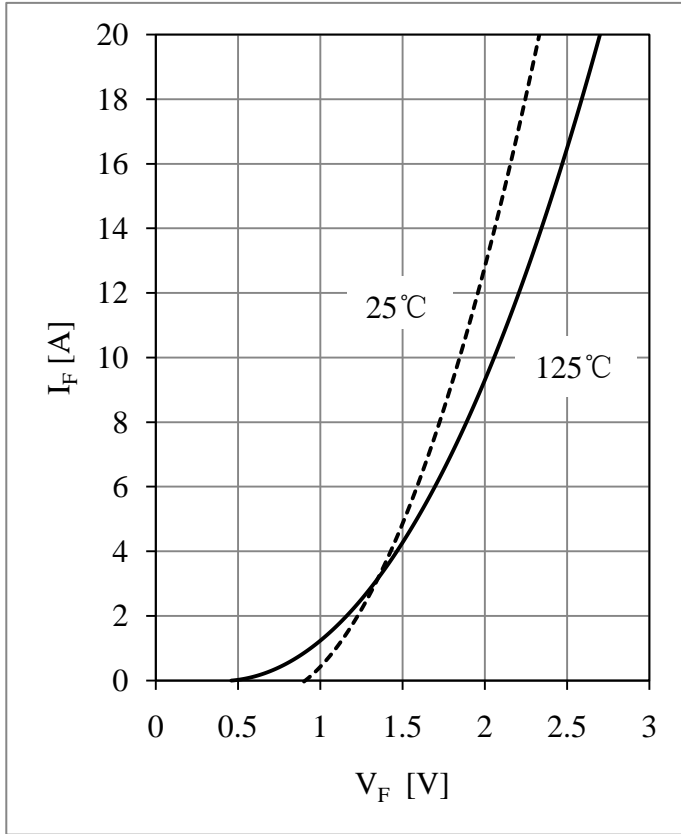


Fig 13. Diode-brake-chopper Forward Characteristics

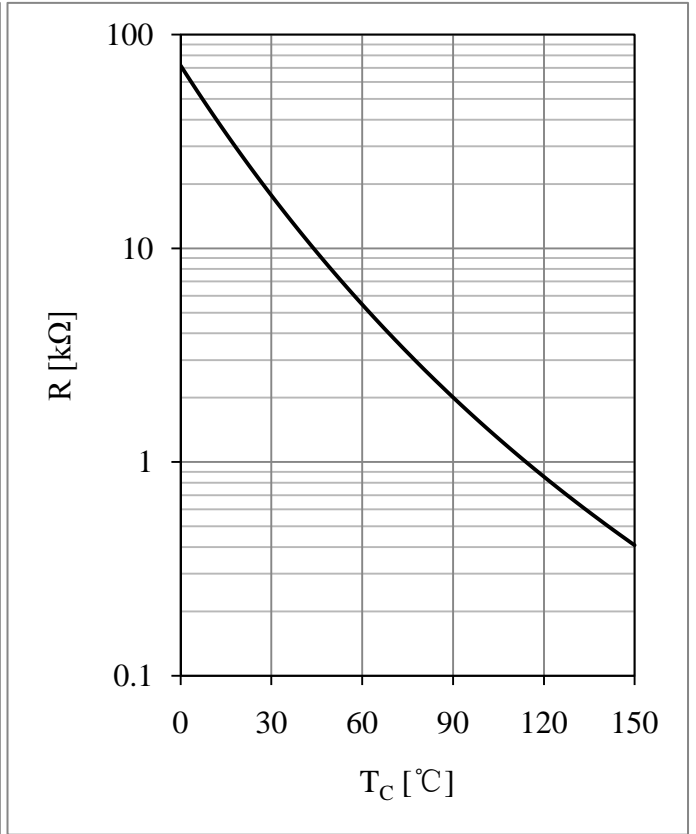
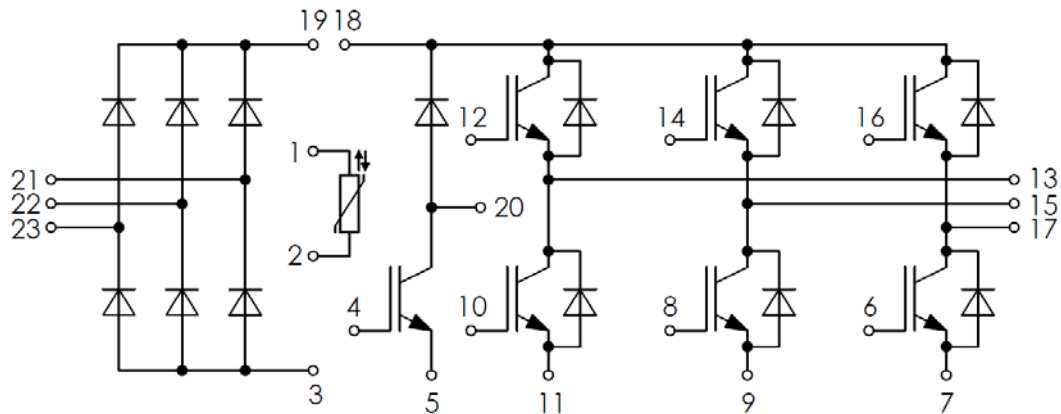


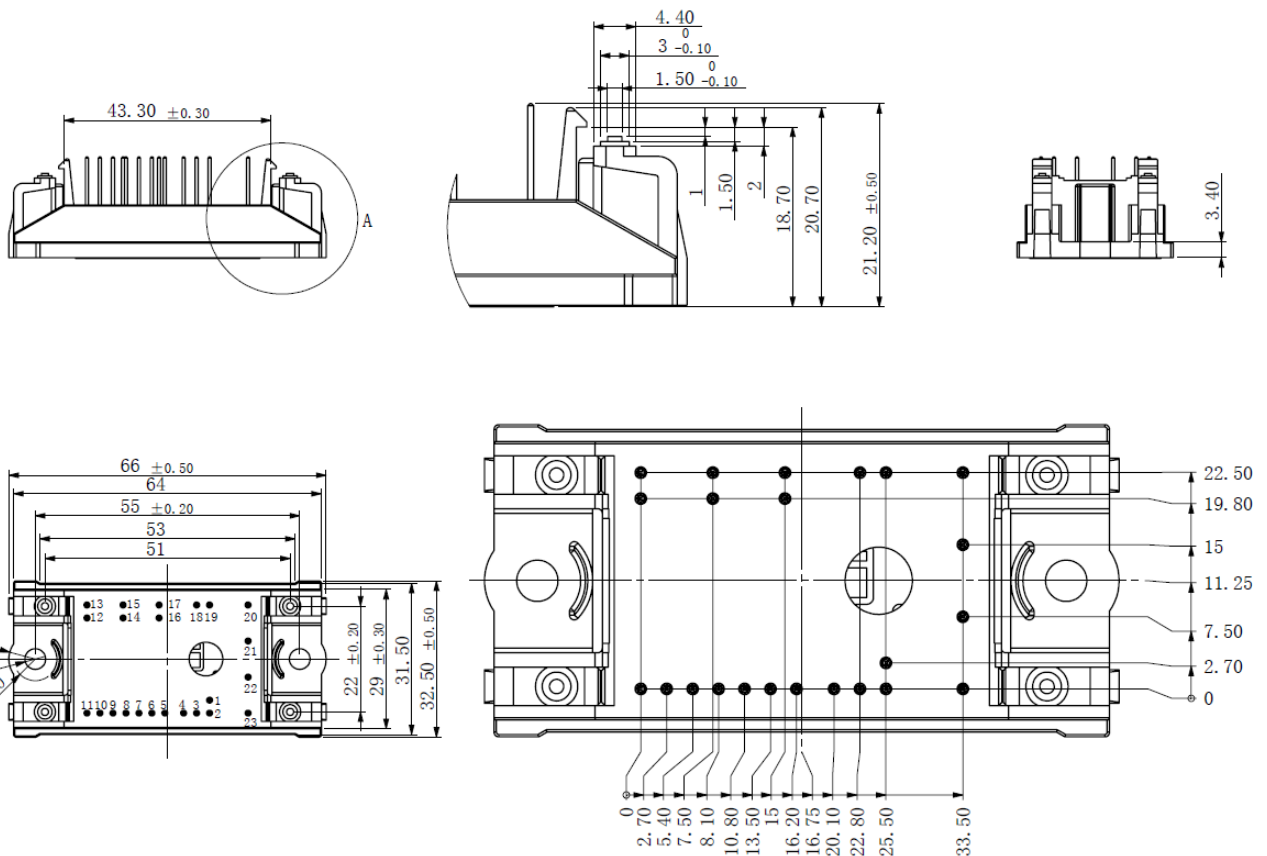
Fig 14. NTC Temperature Characteristic

### Equivalent Circuit Schematic



### Package Dimensions

Dimensions in Millimeters



## Terms and Conditions of Usage

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Should you intend to use the Product in aviation applications, in health or live endangering or life support applications, please notify.

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